Small Signal MOSFET

60 V, 380 mA, Single, N-Channel, SOT-23

Features

- ESD Protected
- Low R_{DS(on)}
- Surface Mount Package
- This is a Pb-Free Device

Applications

- Low Side Load Switch
- Level Shift Circuits
- DC-DC Converter
- Portable Applications i.e. DSC, PDA, Cell Phone, etc.

MAXIMUM RATINGS (T_J = 25°C unless otherwise stated)

Rating	Symbol	Value	Unit	
Drain-to-Source Voltage		V _{DSS}	60	V
Gate-to-Source Voltage		V _{GS}	±20	V
Drain Current (Note 1) Steady State t < 5 s	$T_A = 25^{\circ}C$ $T_A = 85^{\circ}C$ $T_A = 25^{\circ}C$ $T_A = 85^{\circ}C$	ID	320 230 380 270	mA
Power Dissipation (Note 1) Steady State t < 5 s		P _D	300 420	mW
Pulsed Drain Current (t _p = 10 μs)		I _{DM}	1.5	Α
Operating Junction and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C	
Source Current (Body Diode)	Is	300	mA	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		TL	260	°C
Gate-Source ESD Rating (HBM, Method 3015)		ESD	2000	V

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Junction-to-Ambient - Steady State (Note 1)	$R_{ heta JA}$	417	°C/W
Junction-to-Ambient - t ≤ 5 s (Note 1)	$R_{\theta JA}$	300	

Surface-mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces)

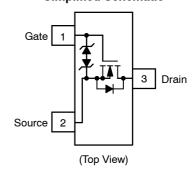


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V _{(BR)DSS}	R _{DS(on)} MAX	I _D MAX (Note 1)	
60 V	1.6 Ω @ 10 V	380 mA	
	2.5 Ω @ 4.5 V		

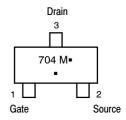
Simplified Schematic



MARKING DIAGRAM & PIN ASSIGNMENT



SOT-23 CASE 318 STYLE 21



704 = Specific Device Code M = Date Code

■ = Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or position may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]		
2N7002KT1G	SOT-23 (Pb-Free)	3000/Tape & Reel		

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Co	ndition	Min	Тур	Max	Units
OFF CHARACTERISTICS	-	•			•		•
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /T _J				71		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V,	T _J = 25°C			1	μΑ
		V _{DS} = 60 V	T _J = 125°C			500	
		V _{GS} = 0 V, V _{DS} = 50 V	T _J = 25°C			100	nA
Gate-to-Source Leakage Current	I_{GSS} $V_{DS} = 0 \text{ V, } V_{GS} = \pm$		/ _{GS} = ±20 V			±10	μΑ
		V _{DS} = 0 V, \	/ _{GS} = ±10 V			450	nA
		V _{DS} = 0 V, V	′ _{GS} = ±5.0 V			150	nA
ON CHARACTERISTICS (Note 2)	•	•					
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}$	I _D = 250 μA	1.0		2.5	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				4.0		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	$R_{DS(on)}$ $V_{GS} = 10 \text{ V}, I_D = 500 \text{ mA}$			1.19	1.6	Ω
		V _{GS} = 4.5 V, I _D = 200 mA			1.33	2.5	
Forward Transconductance	9FS	V _{DS} = 5 V, I _D = 200 mA			80		S
CHARGES AND CAPACITANCES	•						
Input Capacitance	C _{ISS}	$V_{GS} = 0 \text{ V, f} = 1 \text{ MHz,}$ $V_{DS} = 20 \text{ V}$			24.5		pF
Output Capacitance	C _{OSS}				4.2		
Reverse Transfer Capacitance	C _{RSS}				2.2		
Total Gate Charge	Q _{G(TOT)}				0.7		nC
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V,	V _{DS} = 10 V;		0.1		
Gate-to-Source Charge	Q_{GS}		00 mA		0.3		
Gate-to-Drain Charge	Q_{GD}	1			0.1		1
SWITCHING CHARACTERISTICS, V _{GS}	= V (Note 3)			•			
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 10 V, V_{DD} = 25 V, I_{D} = 500 mA, R_{G} = 25 Ω			12.2		ns
Rise Time	t _r				9.0		
Turn-Off Delay Time	t _{d(OFF)}				55.8]
Fall Time	t _f				29		
DRAIN-SOURCE DIODE CHARACTER	IISTICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	T _J = 25°C		0.8	1.2	V
		I _S = 200 mA	T _J = 85°C		0.7]

Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%
 Switching characteristics are independent of operating junction temperatures

TYPICAL CHARACTERISTICS

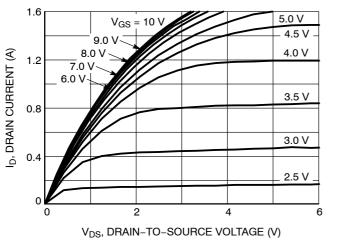


Figure 1. On-Region Characteristics

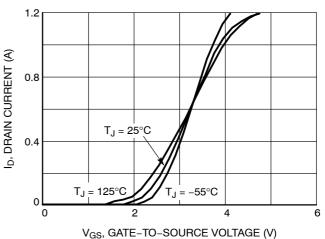


Figure 2. Transfer Characteristics

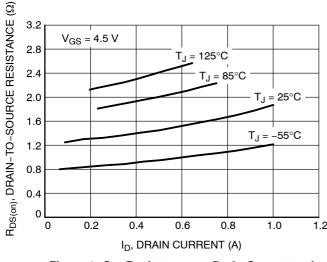


Figure 3. On-Resistance vs. Drain Current and Temperature

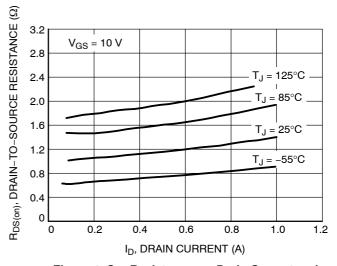


Figure 4. On-Resistance vs. Drain Current and Temperature

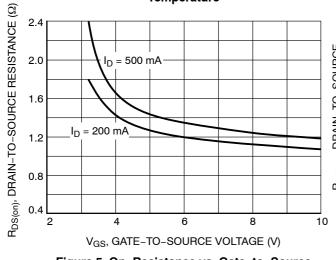


Figure 5. On-Resistance vs. Gate-to-Source Voltage

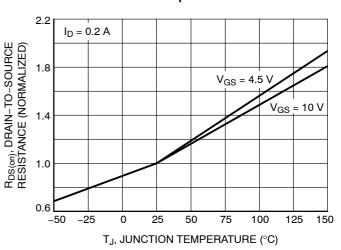


Figure 6. On–Resistance Variation with Temperature

TYPICAL CHARACTERISTICS

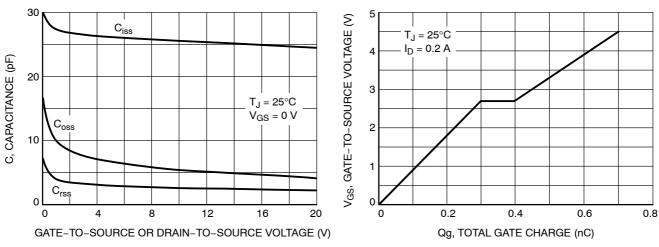


Figure 7. Capacitance Variation

Figure 8. Gate-to-Source and Drain-to-Source Voltage vs. Total Charge

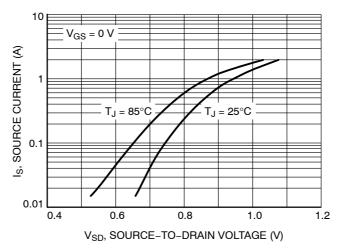
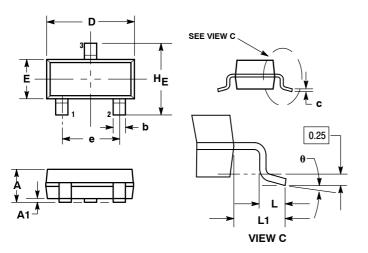


Figure 9. Diode Forward Voltage vs. Current

PACKAGE DIMENSIONS

SOT-23 (TO-236) CASE 318-08 **ISSUE AN**



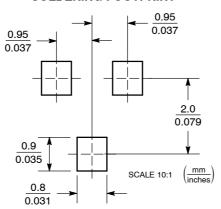
NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH.
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS IN THE MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
 4. 318-01 THRU -07 AND -09 OBSOLETE, NEW STANDARD

	MILLIMETERS			INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.89	1.00	1.11	0.035	0.040	0.044
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.37	0.44	0.50	0.015	0.018	0.020
С	0.09	0.13	0.18	0.003	0.005	0.007
D	2.80	2.90	3.04	0.110	0.114	0.120
E	1.20	1.30	1.40	0.047	0.051	0.055
е	1.78	1.90	2.04	0.070	0.075	0.081
L	0.10	0.20	0.30	0.004	0.008	0.012
L1	0.35	0.54	0.69	0.014	0.021	0.029
HE	2.10	2.40	2.64	0.083	0.094	0.104

STYLE 21: PIN 1. GATE 2. SOUR SOURCE

SOLDERING FOOTPRINT



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